

Contact:

#### **NEWS RELEASE**

## **SMIC Reports 2012 Fourth Quarter Results**

All currency figures stated in this report are in US Dollars unless stated otherwise. The financial statement amounts in this report are determined in accordance with US GAAP.

Shanghai, China – February 6, 2013. Semiconductor Manufacturing International Corporation (NYSE: SMI; SEHK: 981) ("SMIC" or the "Company"), one of the leading semiconductor foundries in the world, today announced its consolidated results of operations for the three months ended December 31, 2012.

### Fourth Quarter 2012 Highlights:

Record high quarterly revenue of \$485.9 million in 4Q12, an increase of 5.4% quarter over quarter, and up 67.8% year over year.

\$189.8 million net cash generated from operations in 4Q12, \$70.8 million more than 3Q12.

Net income of \$39.7 million attributable to Semiconductor Manufacturing International Corporation in 4Q12, compared to \$12.0 million in 3Q12. Diluted EPS was \$0.06 per ADS.

#### First Quarter 2013 Guidance:

The following statements are forward looking statements which are based on current expectations and which involve risks and uncertainties, some of which are set forth under "Safe Harbor Statements" below.

Revenue is expected to be up 1% to down 2%.

Gross margin is expected to range from 17.5% to 19.5%.

Operating expenses excluding the effect of foreign exchange, government R&D grants and assets disposal are expected to range from \$74 million to \$77 million.

2013 capital expenditure for foundry operations is expected to be approximately \$600 million.

Dr. Tzu-Yin Chiu, SMIC's Chief Executive Officer and Executive Director, commented, "I am

customers grew 34.1% in 2012 over 2011, while employing our full spectrum of technology from 0.35-micron to 40nm.

"Our 45/40nm process commenced volume shipment in the fourth quarter, and its contribution more than tripled quarter-over-quarter to 2.6% of revenue. Our 28nm offering is on track and both HKMG and PolySiON processes are targeted to be ready by the fourth quarter of 2013.

"As the leading and most advanced foundry provider in China, we have upgraded our technology portfolio, services and quality to help all of our customers participate in the rapidly growing China semiconductor market. The latest survey published by the Ministry of Industry and Information Technology's China Software and Integrated Circuit Promotion Center (CSIP) in November 2012 specifies that approximately 75% of Chinese fabless companies choose SMIC as their preferred foundry partner in 2012, a noticeable and significant improvement as compared to 59% in 2011.

"I am very pleased with SMIC's achievements in 2012, and we are starting 2013 with both excitement and caution. I believe we have the right strategy, the right focus and the right team. We will continue to focus on sustainable profitability, growth, and shareholder value."

#### Conference Call / Webcast Announcement

Date: February 7, 2013

Time: 8:30 a.m. Shanghai time Dial-in numbers and pass code:

 United States
 1-718-354-1231
 (Pass code: SMIC)

 Hong Kong
 852-2475-0994
 (Pass code: SMIC)

 China
 86-80-0819-0121
 (Pass code: SMIC)

 Taiwan
 886-2-2650-7825
 (Pass code: SMIC)

The call will be webcast live with audio at http://www.smics.com/eng/investors/ir\_presentations.php, or at http://www.media-server.com/m/p/d532va5f

An archived version of the webcast, along with an electronic copy of this news release will be available on the SMIC website for a period of 12 months following the webcast.

#### **About SMIC**

Semiconductor Manufacturing International Corporation ("SMIC"; NYSE: SMI; SEHK: 981) is one of the leading semiconductor foundries in the world and the largest and most advanced foundry in mainland China, providing integrated circuit (IC) foundry and technology services at 0.35-micron to 40-nanometer. Headquartered in Shanghai, China, SMIC has a 300mm wafer fabrication facility (fab) and a 200mm mega-fab in Shanghai, a 300mm mega-fab in Beijing, a 200mm fab in Tianjin, and a 200mm fab project under development in Shenzhen. SMIC also has customer service and marketing offices in the U.S., Europe, Japan, and Taiwan, and a representative office in Hong Kong. In addition, SMIC manages and operates a 300mm wafer fab in Wuhan owned by Wuhan Xinxin Semiconductor Manufacturing Corporation.

For more information, please visit www.smics.com.

#### **Safe Harbor Statements**

(Under the Private Securities Litigation Reform Act of 1995)

This press release contains, in addition to historical information, "forward-looking statements" w



## Summary of Fourth Quarter 2012 Operating Results

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•	4Q12	3Q12	QoQ	4Q11	YoY
Sales	485,894	461,168	5.4%	289,628	67.8%
Cost of sales	389,127	334,348			



## **Analysis of Revenue**

Revenue Analysis			
By Application	4Q12	3Q12	4Q11
Computer	1.0%	1.5%	3.3%
Communications	47.4%	46.7%	44.1%
Consumer	42.6%	43.1%	42.5%
Others	9.0%	8.7%	10.1%
By Service Type	4Q12	3Q12	4Q11
Wafers <sup>(1)</sup>	94.0%	94.9%	92.2%
Mask making, testing, others	6.0%	5.1%	7.8%
By Customer Type	4Q12	3Q12	4Q11
Fabless semiconductor companies	86.6%	86.8%	88.5%
Integrated device manufacturers (IDM)	9.3%	8.8%	8.2%
System companies and others	4.1%	4.4%	3.3%
By Geography	4Q12	3Q12	4Q11
North America	54.4%	55.2%	55.9%
China <sup>(2)</sup>	34.8%	35.3%	34.1%
Eurasia <sup>(3)</sup>	10.8%	9.5%	10.0%
Wafer Revenue Analysis		•	
By Technology (logic, memory & copper interconnect only)	4Q12	3Q12	4Q11
40/45 nm	2.6%	0.8%	0.3%
55/65 nm	35.3%	34.8%	21.0%
90 nm	8.0%	9.4%	9.2%
0.13 μm	10.2%	11.8%	22.3%
0.15/0.18 μm	39.9%	37.5%	37.2%
0.25/0.35 μm	4.0%	5.7%	10.0%

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### Capacity\*

Fab / (Wafer Size)	4Q12	3Q12
Shanghai Mega Fab (8")	90,000	90,000
Shanghai 12-inch Fab (12")	13,500	-
Beijing Mega Fab (12")	78,750	78,750
Tianjin Fab (8")	37,000	37,000
Total monthly wafer fabrication capacity	219,250	205,750

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Capacity increased to 219,250 8-inch equivalent wafers in 4Q12 from 205,750 8-inch equivalent wafers in 3Q12, primarily because the Shanghai 12" fab entered into volume production in 4Q12.

## **Shipment and Utilization**

8" equivalent wafers	4Q12	3Q12	QoQ	4Q11	YoY
Wafer shipments including copper					
interconnects	608,372	605,543	0.5%	374,116	62.6%
Utilization rate <sup>(1)</sup>	90.5%	92.0%	-	65.6%	-

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### **Detailed Financial Analysis**

**Gross Profit Analysis** 

Aonn jor ond	4Q12	3Q12	QoQ	4Q11	YoY
Cost of sales	389,127	334,348	16.4%	310,959	25.1%
Depreciation	112,290	93,258	20.4%	106,150	5.8%
Other manufacturing costs	276,367	240,621	14.9%	204,546	35.1%
Share-based compensation	470	469	0.2%	263	78.7%
Gross profit	96,767	126,820	-23.7%	(21,331)	-
Gross margin	19.9%	27.5%	-	-7.4%	-

Cost of sales increased to \$389.1 million in 4Q12, an increase of 16.4% QoQ from \$334.3 million in 3Q12. This was mainly because the Shanghai 12" fab entered volume production in 4Q12 and as a result, all the production related costs were removed from the R&D expense line and treated as manufacturing costs.

Gross profit was \$96.8 million in 4Q12, a decrease of 23.7% QoQ from \$126.8 million in 3Q12, mainly due to the same reason mentioned above.

Gross margin was 19.9% in 4Q12, down from 27.5% in 3Q12, primarily due to the same reason mentioned above. The inclusion of Shanghai 12" fab production related costs led to a 4.4% decrease in gross margin in 4Q12.

Operating Expense (Income) Analysis

Aonn i o nd	4Q12	3Q12	QoQ	4Q11	YoY
Total operating expenses	44,044	106,452	-58.6%	85,667	-48.6%
Research and development	26,676	72,945	-63.4%	38,921	-31.5%
General and administrative	29,437	24,857	18.4%	25,038	17.6%
Selling and marketing	8,629	8,178	5.5%	9,283	-7.0%
Other operating expense (income)	(20,698)	472	-	12,425	-

R&D expenses decreased to \$26.7million in 4Q12, down 64.3% QoQ from \$72.9 million in 3Q12, mainly due to two factors: a) the Shanghai 12" fab entered volume production in 4Q12 and as a result, all the production related costs were removed from the R&D expense line and treated as manufacturing costs and b) R&D grant of \$10.1 million was recorded in 4Q12 compared to \$1.2 million in 3Q12.

General and administrative expense increased to \$29.4 million in 4Q12, up 18.4% QoQ from \$24.8 million in 3Q12, mainly due to employee bonus accrual.

Other operating income in 4Q12 was \$20.7 million mainly due to gain arising from the disposal of part of the living quarters in Shanghai.

Total Other Income (Loss), Net

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Α	onn <sub>/</sub> sond	4Q12	3Q12	QoQ	4Q11	Υ
To	otal other income (loss), net	(2,353)	(7,806)	-69.9%	5,430	
1	nterest income	1,276	1,087			
1	nterest expense	(10,107)	(10,835)			
F	Foreign currency exchange gain	4,434	1,405			

2,044

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**Depreciation and Amortization** 

A o n	n	/ <b>\$</b> 0	nd	4Q12	3Q12
Deprecia	ation	and amo	ortization	139,638	142,833

Liquidity
A o n n → o nd

Other, net

Capital Structure

Aonn j <sup>s</sup> ond	4Q12	3Q12
Cash and cash equivalents	358,490	231,785
Restricted cash	217,603	244,151
•		
Current portion of promissory notes	29,374	29,582
Non-current portion of promissory notes	-	14,482
•		
Short-term borrowings	383,225	410,870
Current portion of long-term debt	184,579	249,404
Long-term debt	528,612	401,000
Total debt	1,096,416	1,061,274
•		
Equity <sup>(1)</sup>	2,269,535	2,228,166
Total debt to equity ratio <sup>(2)</sup>	48.3%	47.6%

## **Recent Highlights and Announcements**

SMIC Added to Ocean Tomo 300 Patent Index (2013-02-02)
Kilopass NVM IP Achieves JEDEC Qualification on High-Demand SMIC 65/55/40nm
Processes (2013-01-31)
Notification of Board Meeting (2013-01-09)
SMIC Selected Again for Hang Seng Corporate Sustainability Index Series (2013-01-07)
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## Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF COMPREHENSIVE INCOME (In US\$ thousands except share data)

	For the three months ended		
	December 31, 2012 (Unaudited)	September 30, 2012 (Unaudited)	
Sales	485,894	461,168	
Cost of sales	389,127	334,348	
Gross profit	96,767	126,820	
Operating expenses:			
Research and development	26,676	72,945	
General and administrative	29,437	24,857	
Selling and marketing	8.	·	

# Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED BALANCE SHEET (In US\$ thousands)

	As of		
	December 31, 2012 (Unaudited)	September 30, 2012 (Unaudited)	
ASSETS			
Current assets:			
Cash and cash equivalents	358,490	231,785	
Restricted cash	217,603	244,151	
Accounts receivable, net of allowances of \$45,340 and \$45,099 at			
December 31, 2012 and September 30, 2012, respectively	278,111	289,117	
Inventories	295,728	262,242	
Prepaid expense and other current assets	124,107	105,873	
Total current assets	1,274,039	1,133,168	
Prepaid land use rights	73,962	75,854	
Plant and equipment, net	2,385,435	2,434,508	
Acquired intangible assets, net	235,378	231,455	
Other long-term assets	104,344	103,809	
TOTAL ASSETS	4,073,158	3,978,794	
LIABILITIES, NONCONTROLLING INTEREST AND EQUITY			
Current liabilities:			
Accounts payable	331,394	343,810	
Accrued expenses and other current liabilities	186,429	163,507	
Short-term borrowings	383,225	410,870	
Current portion of promissory notes	29,374	29,582	
Current portion of long-term debt	184,579	249,404	
Total current liabilities	1,115,001	1,197,173	
Long-term liabilities:			
Promissory notes	0	14,482	
Long-term debt	528,612	401,000	
Other long-term liabilities	155,785	134,091	
Total long-term liabilities	684,397	549,573	
Total liabilities	1,799,398	1,746,746	
Noncontrolling interest	5,176	4,972	
Ordinary shares, \$0.0004 par value, 50,000,000,000 shares authorized,			
32,000,139,623 and 31,986,671,530 shares issued and outstanding at			
December 31, 2012 and September 30, 2012, respectively	12,800	12,795	
Additional paid-in capital	4,246,744	4,244,895	
Accumulated other comprehensive loss	3,916	3,918	
Accumulated deficit	(1,994,876)	(2,034,532)	
Total equity	2,268,584	2,227,076	
TOTAL LIABILITIES, NONCONTROLLING INTEREST AND EQUITY	4,073,158	3,978,794	

# Semiconductor Manufacturing International Corporation CONDENSED CONSOLIDATED STATEMENT OF CASH FLOWS (In \$US thousands)